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RD Number: RD191

RD Title: FET(SSM6K513NU) board BOM for motor pre-driver IC board

Item No.	Designator	Quantity	Value	Part Number	Manufacturer	Description	Package	Not Mount
1	FET	6	SSM6K513NU	SSM6K513NU	TOSHIBA	MOSFET	UDFN6B	
2	CON	1	Pin header 16P	—	—	Board to board right angle 16pin header		

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